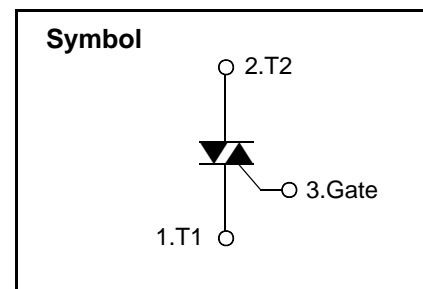
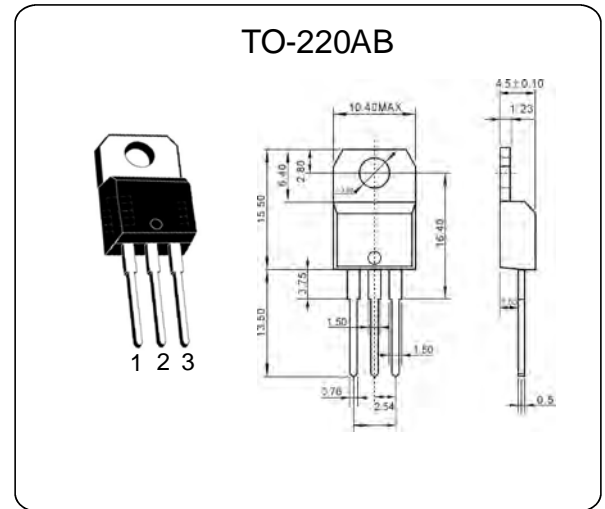


## Bi-Directional Triode Thyristor

Designed for high performance full-wave ac control applications where high noise immunity and high commutating di/dt are required.

### Features

- Blocking Voltage to 800 V
- On-State Current Rating of 16A RMS at 80°C
- Uniform Gate Trigger Currents in Three Quadrants
- High Immunity to dV/dt-1500V/us minimum at 125°C
- Minimizes Snubber Networks for Protection
- Industry Standard TO-220AB Package
- High Commutating dI/dt- 4.0A/ms minimum at 125°C
- Internally Isolated (2500VRMS)
- These are Pb-Free Devices



### Absolute Maximum Ratings

Symbol	Parameter		Value	Unit	
I <sub>T(RMS)</sub>	RMS on-state current(full sine wave)	TO-220AB TC=100°C	16	A	
		TO-220AB Ins. TC=85°C			
I <sub>TSM</sub>	Non repetitive surge peak on-state current(full cycle, T <sub>j</sub> initial=25°C)	F=50Hz t=20ms	160	A	
		F=60Hz t=16.7ms	168		
I <sup>2</sup> t	I <sup>2</sup> t Value for fusing	tp=10ms	144	A <sup>2</sup> s	
DI/DT	Critical rate of rise of on-state current IG=2XIGT, tr≤100ns	F=120Hz Tj=125°C	50	A/us	
VDSM/V RSM	Non repetitive surge peak off-state voltage	tp=10ms Tj=25°C	Vdrm / vrrm + 100V	V	
IGM	Peak gate current	tp=20us Tj=125°C	4	A	
P <sub>G(AV)</sub>	Average gate power dissipation		Tj=125°C	1	W
T <sub>stg</sub>	Storage junction temperature range		-40 to +150	°C	
T <sub>j</sub>	Operating junction temperature range		-40 to +125		

## Electrical Characteristics (T<sub>j</sub>=25 °C, unless otherwise specified)

### Snubberless™ and Logic Level (3 quadrants)

Symbol	Test conditions	Quadrant	BTA16		Unit
I <sub>GT</sub> (1)	V <sub>D</sub> =12V R <sub>L</sub> =33Ω	I - II - III	MAX	50	mA
V <sub>GT</sub>		I - II - III	MAX	1.3	V
V <sub>GD</sub>	V <sub>D</sub> =V <sub>DRM</sub> R <sub>L</sub> =3.3KΩ T <sub>j</sub> =125 °C	I - II - III	MIN	0.2	V
I <sub>H</sub> (2)	I <sub>T</sub> =500mA		MAX	50	mA
I <sub>L</sub>	I <sub>G</sub> =1.2I <sub>GT</sub>	I - III	MAX	70	mA
		II		80	
Dv / Dt(2)	V <sub>D</sub> =67%V <sub>DRM</sub> Gate open T <sub>j</sub> =125 °C		MIN	1000	V/us
(DI/dt) <sub>c</sub> (2)	(Dv/dt) <sub>c</sub> =0.1V/us T <sub>j</sub> =125 °C		MIN	-	A/ms
	(Dv/dt) <sub>c</sub> =10V/us T <sub>j</sub> =125 °C			-	
	Without snubber T <sub>j</sub> =125 °C			14	

### Standard (4 Quadrants)

Symbol	Test conditions	Quadrant	BTA16		Unit
I <sub>GT</sub> (1)	V <sub>D</sub> =12V R <sub>L</sub> =33Ω	I - II - III	MAX	50	mA
		IV		100	
V <sub>GT</sub>		ALL	MAX	1.3	V
V <sub>GD</sub>	V <sub>D</sub> =V <sub>DRM</sub> R <sub>L</sub> =3.3KΩ T <sub>j</sub> =125 °C	ALL	MIN	0.2	V
I <sub>H</sub> (2)	I <sub>T</sub> =500mA		MAX	50	mA
I <sub>L</sub>	I <sub>G</sub> =1.2I <sub>GT</sub>	I - III - IV	MAX	60	mA
		II		120	
(DI/dt)(2)	V <sub>D</sub> =67%V <sub>DRM</sub> Gate open T <sub>j</sub> =125 °C		MIN	400	V/us
(DI/dt) <sub>c</sub> (2)	(Dv/dt) <sub>c</sub> =7A/ms T <sub>j</sub> =125 °C		MIN	10	V/us

### Static Characteristics

Symbol	Test conditions			Value	Unit
V <sub>TM</sub> (2)	I <sub>TM</sub> =22A t <sub>p</sub> =380us	T <sub>J</sub> =25 °C	MAX	1.55	V
V <sub>to</sub> (2)	Threshold voltage	T <sub>J</sub> =125 °C	MAX	0.85	V
R <sub>d</sub> (2)	Dynamic resistance	T <sub>J</sub> =125 °C	MAX	25	mΩ
I <sub>DRM</sub> I <sub>R</sub> RRM	V <sub>DRM</sub> =V <sub>R</sub> RRM	T <sub>J</sub> =25 °C	MAX	5	uA
		T <sub>J</sub> =125 °C		2	mA
V <sub>DRM</sub> /V <sub>R</sub> RRM	Voltage	T <sub>J</sub> =25 °C	MIN	800	V

**Note 1:** minimum I<sub>GT</sub> is guaranteed at 5% of I<sub>GT</sub> max

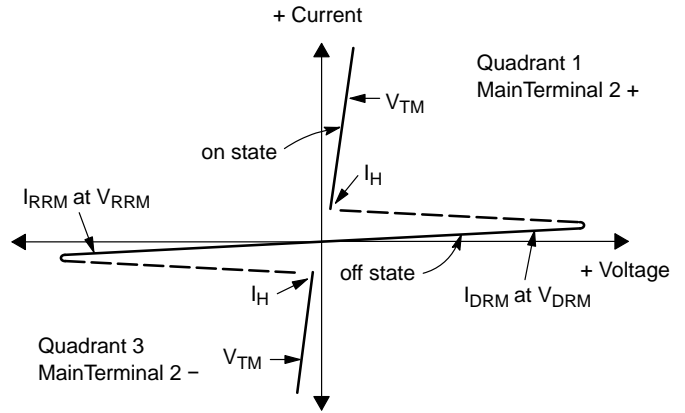
**Note 2:** for both polarities of A2 referenced to A1

### Thermal Resistances

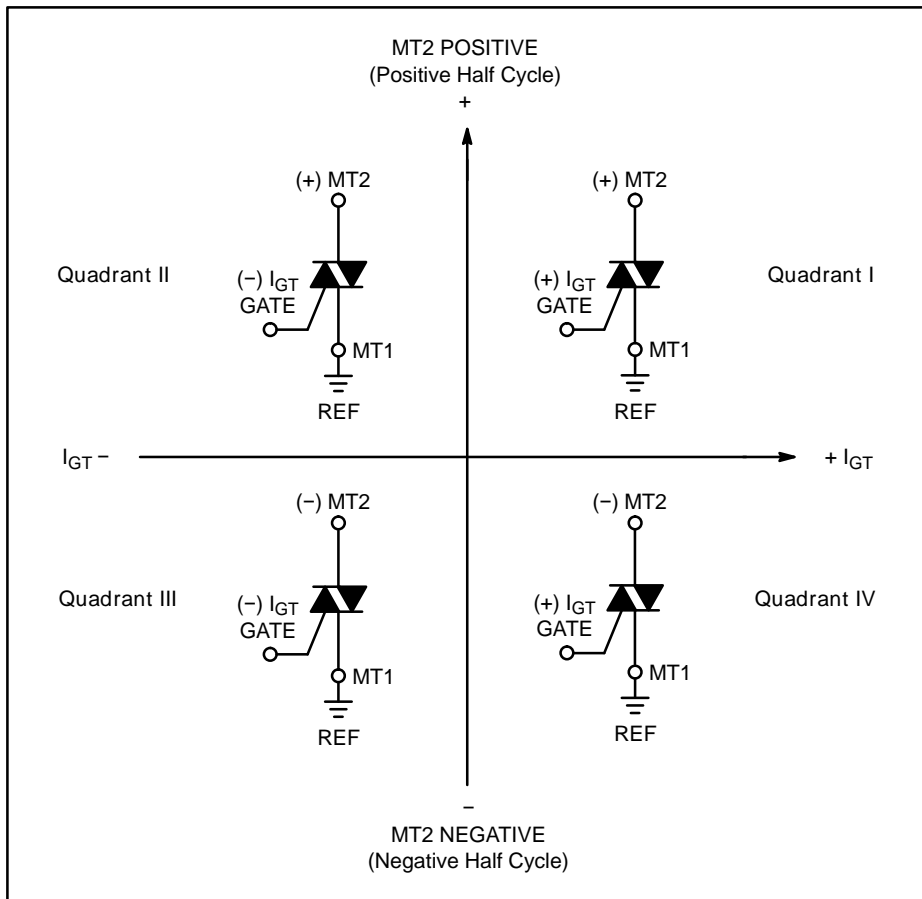
Symbol	Parameter		Value	Unit
R <sub>th(j-c)</sub>	Junction to case(AC)	TO-220AB	1.2	°C/W
		TO-220AB(Insulated)	2.1	
R <sub>th(j-a)</sub>	Junction to ambient	TO-220AB/ TO-220AB(Insulated)	60	°C/W

## Voltage Current Characteristic of Triacs (Bidirectional Device)

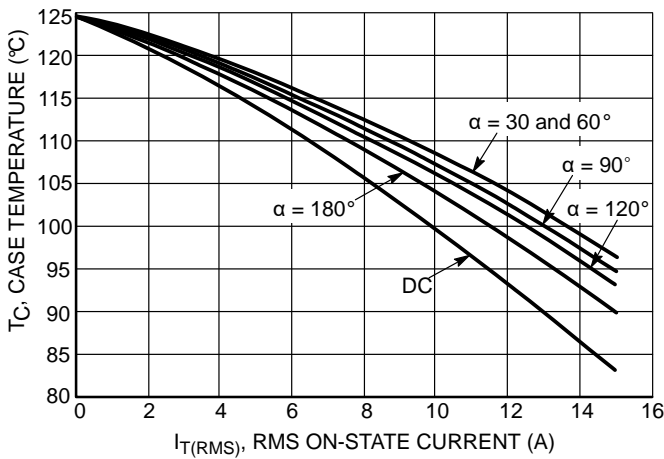
Symbol	Parameter
$V_{DRM}$	Peak Repetitive Forward Off State Voltage
$I_{DRM}$	Peak Forward Blocking Current
$V_{RRM}$	Peak Repetitive Reverse Off State Voltage
$I_{RRM}$	Peak Reverse Blocking Current
$V_{TM}$	Maximum On State Voltage
$I_H$	Holding Current



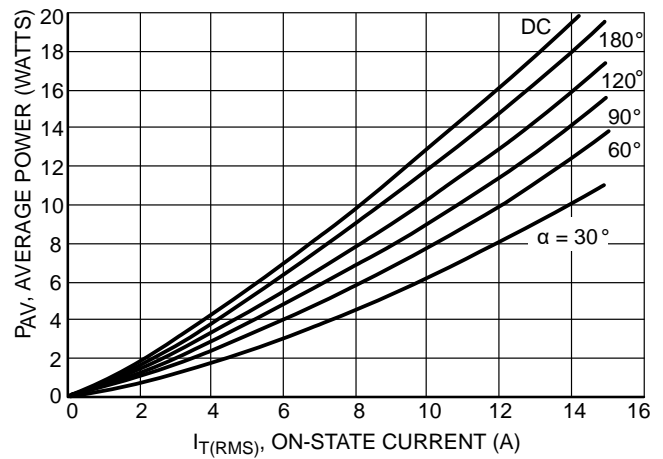
### Quadrant Definitions for a Triac



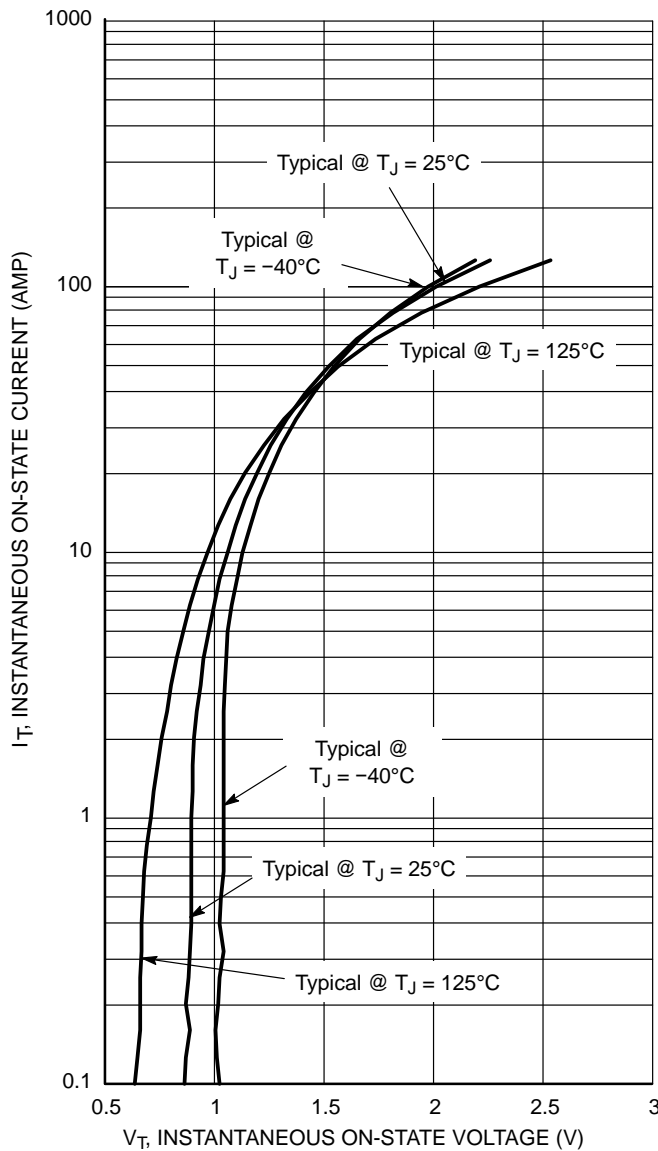
All polarities are referenced to MT1.  
With in-phase signals (using standard AC lines) quadrants I and III are used.



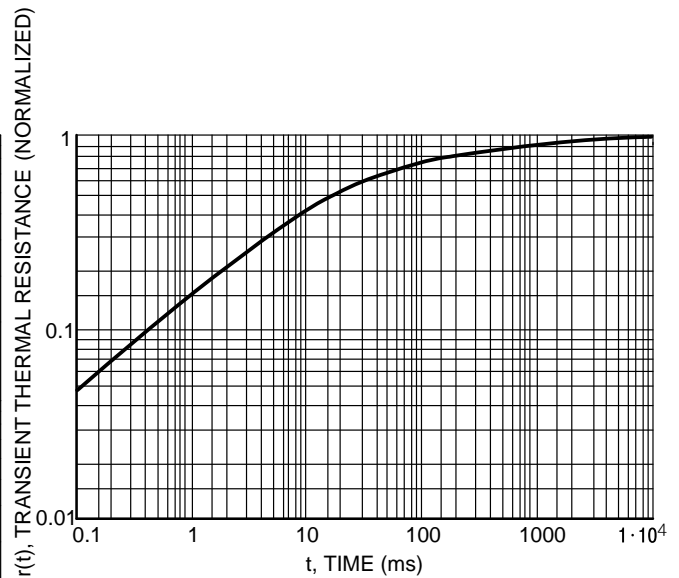
**Figure 1. RMS Current Derating**



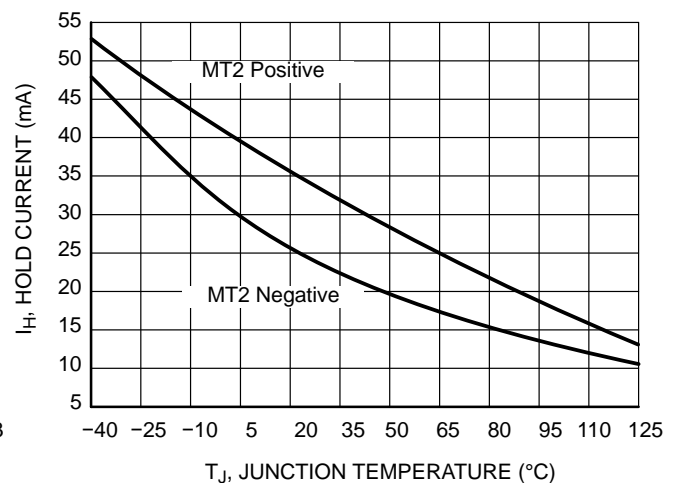
**Figure 2. On-State Power Dissipation**



**Figure 3. On-State Characteristics**



**Figure 4. Thermal Response**



**Figure 5. Hold Current Variation**

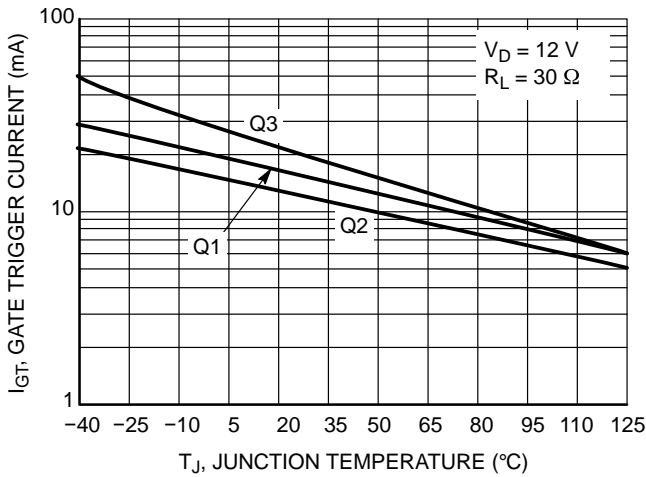


Figure 6. Gate Trigger Current Variation

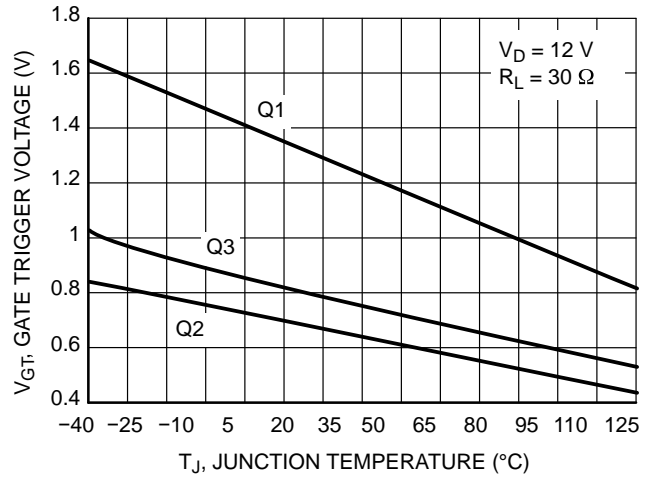


Figure 7. Gate Trigger Voltage Variation

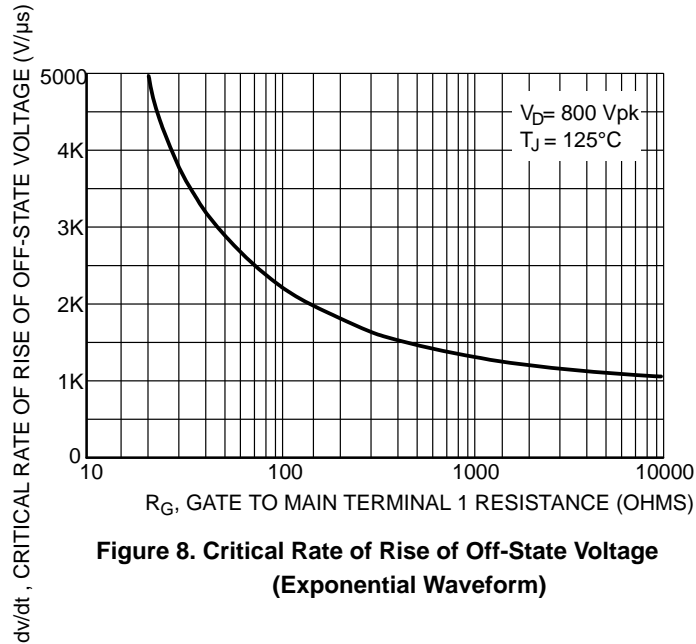
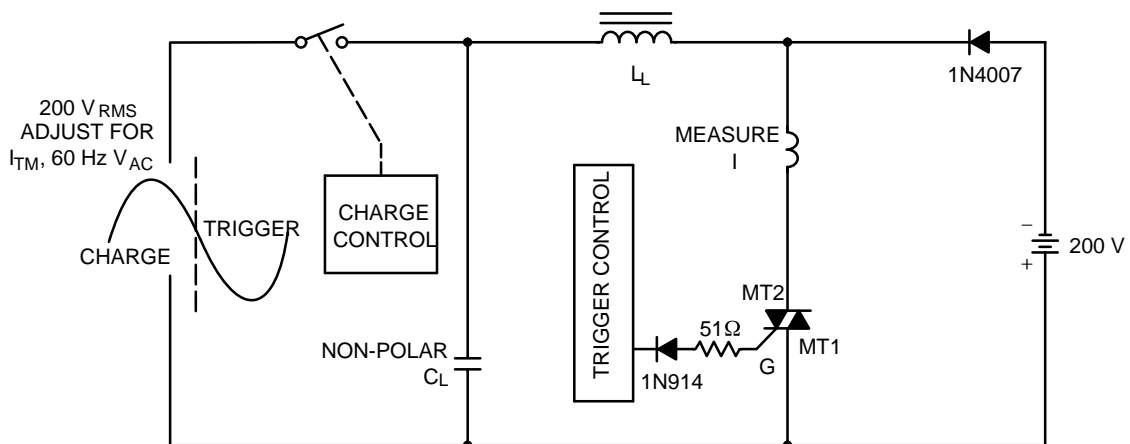


Figure 8. Critical Rate of Rise of Off-State Voltage (Exponential Waveform)



Note: Component values are for verification of rated  $(di/dt)_c$ . See AN1048 for additional information.

Figure 9. Simplified Test Circuit to Measure the Critical Rate of Rise of Commutating Current  $(di/dt)_c$